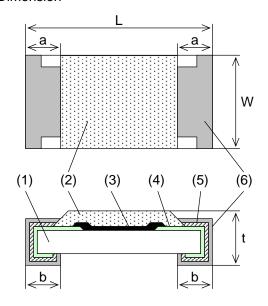
Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 1

1. Dimension



(1) Substrate: Alumina

(2) Protective Coating: Resin

(3) Resistive Element : Metal glaze

(4) Inner Termination: Thick film material

(5) Middle Termination : Ni Plating

(6) Outer Termination: Sn Plating

	L	W	а	b	t
Dimension (mm)	0.60+/-0.03	0.30+/-0.03	0.10+/-0.05	0.15+/-0.05	0.23+/-0.03

2. Power Derating Curve

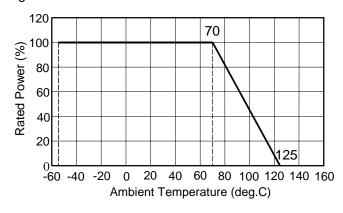


Figure 1

Operating temperature range

: -55 to 125 deg.C

3. Ratings

3-1 Resistor

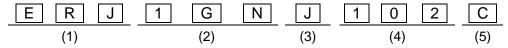
Item	Rated value	Explanation
		When used at ambient temperature above 70
Power Rating	0.05W	deg.C, power rating shall be determined in
		accordance with Figure 1.

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 2

Item	Rated value			Explanati	on
Rated voltage & Rated Continuous Working Voltage	The rated voltage of each resistance should be calculated from the equation below. And when the rated voltage exceeds the maximum RCWV, the maximum RCWV should be the rated voltage. Rated voltage = (Power rating x Resistance Value) 1/2 The maximum RCWV: 25V For Jumper: Rated current 0.5 A				
Overload Voltage	The overload voltage should be 2.5 times the rated voltage. And when the voltage exceeds the maximum overload voltage, the maximum overload voltage should be the overload voltage. The maximum overload voltage : 50V				
Resistance Tolerance	For Jumper: Overload current 1 A Code Tolerance F +/-1% J +/-5% 0 Jumper				
Resistance	Code F J	10 ohm – 1.0 ohm –	1.0M ohm 1.0M ohm 50m ohm	Series E-24,E96 E24	

4. Explanation of Part Number

4-1 (Resistance: J)



(1) Product Code: Thick Film Chip Resistor

(2) Size and Rated Power: 0.6 mm x 0.3 mm, 0.05 W

(3) Resistance Tolerance

Code	Resistance Tolerance
J	+/- 5%
0	Jumper

(4) Resistance Value

The first two digits are the significant figures of resistance value, and the last figure shows the number of zero following in ohm. And " R " means decimal point, and the other two digits are significant figures of resistance value following in ohm.

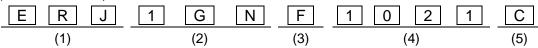
And "R00" means jumper.

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 3

(5) Packaging Configuration

Code	Packaging Configuration
О	Taping (15000pcs/reel)

4-2 (Resistance: F)



- (1) Product Code: Thick Film Chip Resistor
- (2) Size and Rated Power: 0.6 mm x 0.3 mm, 0.05 W
- (3) Resistance Tolerance

Code	Resistance Tolerance
F	+/- 1%

(4) Resistance Value

The first three digits are the significant figures of resistance value, and the last figure shows the number of zero following in ohm. And "R" means decimal point, and the other three digits are significant figures of resistance value following in ohm.

(5) Packaging Configuration

Code	Packaging Configuration
С	Taping (15000pcs/reel)

5. Appearance & Construction

Item	Specification	Explanation
Appearance & Construction	fade easily. The surface of and discoloration. 2. The electrode should be purely that the plating should not fad pinhole, projection and discoloration. 3. The electrode should be delement. 4. Dimensions of the substrate	te should be as in the list and it should not and crack. Details of appearance criteria shall

As far as there shall not designation especially, the following tests and measurement shall be operated under the following conditions.

Normal temperature : 15 deg.C to 35 deg.C

Normal humidity : 25 % to 75 %

Normal atmospheric pressure: 86 k Pa to 106 k Pa

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 4

6. Performance Specification

Performance Specification					
Item	Specification		Test Method (JIS-C5201-1)		
item	Resistor	Jumper	rest Method (313-C3201-1)		
DC resistance	DC resistance value shall be within the specified tolerance.	Less than 50m ohm	At 20 deg.C, 65%RH		
	1.0 ohm – 9.1 oh	nm	Natural resistance change per temperature		
	: +600/-100 x 1	0 ⁻⁶ /deg.C	degree centigrade.		
Temperature	10 ohm – 1 M ohm		$TCR=(R_2-R_1)x10^6/R_1(t_2-t_1)$ (x10 ⁻⁶ /deg.C)		
coefficient	: +/- 200 x 10 ⁻⁶ /deg.C		R ₁ : Resistance value at reference		
of resistance	1.1 M ohm – 10 M ohm		temperature (t ₁)		
(TCR)	: +150/-400 x 10 ⁻⁶ /deg.C		R ₂ : Resistance value at test		
	Chip jumper		temperature (t ₂)		
	: Less than 50	mΩ	t ₁ : 25 deg.C , t ₂ : 125 deg.C		
Short time	ΔR :	Less than	Resistors shall be applied 2.5 times the rated		
overload	ΔK . +/-(2%+0.1ohm)	50m ohm	voltage for 5 seconds.		
Overload	+/-(2 /0+0.1011111)	John Ohin	Max. overload voltage shall be 50V.		
			Resistors shall be subjected to 10000 cycles		
Intermittent	ΔR :	Less than	of 2.5 times the rated voltage applied for 1		
overload	ΔK . +/-(5%+0.1ohm)	50m ohm	second with pause of 25 seconds between		
Overioau	+/-(3 /0+0.1011111)	JUIN UNIN	tests.		
			Max. overload voltage shall be 50V.		

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 5

	ERJ1GN			10 - 5			
7.	7. Machinery characteristic						
	Item	Specifica	1	Test Method (JIS-C	5201-1)		
-		Resistor	Jumper	(0.0			
				Substrate : Glass epoxy (t=1.0 mm)			
				Span: 90mm			
		No mechanical da	anama	Bending distance : 3mm (10 seconds)			
		TWO INCONGRICAL GO	inago.	<test pattern=""> 0.3 0.3 0.3</test>			
	Bending			0.3	(mm)		
	strength						
					04		
		ΔR :	Less than				
		+/-(1%+0.05ohm)	50m ohm				
				400	→		
-				100			
		Termination should be covered uniformly with solder (Min. 95% coverage)		Resistors shall be dipped in the melted solder			
	Caldarahilitu			bath at 235 deg.C +/- 5 deg.C for 2 seconds +/- 0.5 second. Flux shall be removed from			
	Solderability			the surface of termination with clean organic			
				solvent.			
=				Resistors shall be dipped in	the melted solder		
	Resistance to	ΔR :	Less than	bath at 270 deg.C +/- 3 deg.C for 10 seconds			
	soldering heat	+/-(1%+0.05ohm)	50m ohm	+/- 1 second.			
				Resistors shall be subjected	to a single		
				vibration having as double a	mplitude of 1.5		
	Resistance to	4D .	Less than	mm in 3 directions perpendicular one another			
	vibration	ΔR : +/-(1%+0.05ohm)	50m ohm	for 2 hours each. (6 hours in total)			
	(Low frequency)	+/-(1%+0.0301111)	00111 011111	The vibration frequency shall	be varied		
				uniformly from 10 Hz to 55 Hz, and return			
-				to 10 Hz traversing for 1 mir	n.		
		Without distinct		Solvent solution : Isopropyl a			
	D	deformation in ap	pearance	(1) Dipping 10 +/- 1 hours, dry in room			
	Resistance to	4D .		condition for 30 +/- 10 mil			
	solvent	ΔR :	Less than	(2)Ultrasonic wave washing :			
		+/-(0.5%	50m ohm	(0.3W/cm,28kHz) Dry in room condition for 30 +/-10 minutes.			
L		+0.05ohm)		Dry in room condition for	ou +/- iu minutes.		

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 6

8. Environmental test

Item	Specification		Test Method (JIS-C5201-1)		
nem	Resistor	Jumper	rest Method (313-C3201-1)		
Low temperature exposure	ΔR : +/-(1%+0.05ohm)	Less than 50m ohm	Resistors shall be exposed at -55 deg.C +/- deg.C with no load for 1000 hours +48/-0 hours.		
High temperature exposure	ΔR : +/-(1%+0.05ohm)	Less than 50m ohm	Resistors shall be exposed at 125 deg.C +/- 3 deg.C with no load for 1000 hours +48/-0 hours.		
Temperature cycling	ΔR : +/-(1%+0.05ohm)	Less than 50m ohm	Resistors shall be tested for 5 cycles continuously in accordance with the following duty cycle. Step Temperature (deg.C) Time (min.) 1 -55 +/-3 30 2 Room temperature Max. 3 3 +125 +/-3 30 4 Room temperature Max.3		
Humidity (Steady state)	ΔR : +/-(1%+0.05ohm)	Less than 50m ohm	Resistors shall be exposed at 60 deg.C +/- 2 deg.C and 90% to 95% relative hummidity in a humidity test chamber for 1000 hours +48/-0 hours.		
Load life	ΔR : +/-(3%+0.1ohm)	Less than 50m ohm	Resistors shall be operated at DC rated Voltage (1.5 hours "ON", 0.5 hours "OFF") f 1000 hours +48/-0 hours in a test chamber controlled at 70 deg.C +/-2 deg.C.		
Load life in humidity	ΔR : +/-(3%+0.1 ohm)	Less than 50m ohm	Resistors shall be operated at DC rated Voltage (1.5 hours "ON", 0.5 hours "OFF") for 1000 hours +48/-0 hours in a test chamber controlled at 60 deg.C +/- 2 deg.C and at 90 % to 95% in relative hummidity.		

9. Resistance value marking No marking

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 7

10. Common precautions in handling resistors

!\ Notice for use

- (1) This specification shows the quality and performance of a unit component. Before adoption, be sure to evaluate and verify the product mounting it in your product.
- (2) We take no responsibility for troubles caused by the product usage that is not specified in this specification.
- (3) Use fail-safe design and ensure safety by carrying out the following items in cases where it is forecast that the failure of the product gives serious damage to something important like human life, for instant in traffic transportation equipment (trains, cars, traffic signal equipment, etc.), medical equipment, aerospace equipment, electric heating appliances, combustion and gas equipment, rotating equipment, disaster and crime preventive equipment.
 - *Ensure safety as the system by setting protective circuits and protective equipment.
 - *Ensure safety as the system by setting such redundant circuits as do not cause danger by a single failure.
- (4) When a dogma shall be occurred about safety for this product, be sure to inform us rapidly, operate your technical examination.
- (5) The product is designed to use in general standard applications of general electric equipment (AV products, household electric appliances, office equipment, information and communication equipment, etc.); hence, it do not take the use under the following special environments into consideration.
 - Accordingly, the use in the following special environments, and such environmental conditions may affect the performance of the product; prior to use, verify the performance, reliability, etc. thoroughly.
 - 1) Use in liquids such as water, oil, chemical, and organic solvent.
 - 2) Use under direct sunlight, in outdoor or in dusty atmospheres.
 - 3) Use in places full of corrosive gases such as sea breeze, Cl₂, H₂S, NH₃, SO₂, and NO_X.
 - 4) Use in environment with large static electricity or strong electromagnetic waves.
 - 5) Where the product is close to a heating component, and where an inflammable such as a polyvinyl chloride wire is arranged close to the product.
 - 6) Where the resistor is sealed or coated with resin, etc.
 - 7) Where water or a water-soluble detergent is used in cleaning free soldering and in flux cleaning after soldering (Pay particular attention to soluble flux.)
 - 8) Use in such a place where the product is wetted due to dew condensation.
- (6) If transient load (heavy load in a short time) like pulse is expected to be applied, carry out evaluation and confirmation test with resistors actually mounted on your own board. When the load of more than rated power is applied under the load condition at steady state, it may impair performance and/or reliability of resistor. Never exceed the rated power. When the product shall be used under special condition, be sure to ask us in advance.
- (7) Halogen type (Chlorine type, Bromine type, etc.) or other high-activity flux is not recommended as the residue may affect performance or reliability of resistors.
- (8) When soldering with soldering iron, never touch the body of the chip resistor with a tip of the soldering iron. When using a soldering iron with a tip at high temperature, solder for a time as short as possible. (three seconds or less up to 350 deg.C)
- (9) Avoid physical shock to the resistor and nipping of the resistor with hard tool (a pair of pliers or tweezers) as it may damage protective film or the body of resistor and may affect resistor's performance.
- (10) Avoid immersion of chip resistor in solvent for long time. Use solvent after the effect of immersion is confirmed.

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 8

11. Storage Method

If the product is stored in the following environments and conditions, the performance and solderability may be badly affected, avoid the storage in the following environments.

- (1) Storage in places full of corrosive gases such as sea breeze, Cl₂, H₂S, NH₃, SO₂, and NO_X.
- (2) Storage in places exposed to direct sunlight.
- (3) Storage in places outside the temperature range of 5 deg.C to 35 deg.C and humidity range of 45 %RH to 85 %RH.
- (4) Storage over a year after our delivery (This item also applies to the case where the storage method specified in item (1) to (3) has been followed.).

12. Laws and Regulations

- (1) No ODCs or other ozone-depleting substances that are subject to regulation under the Montreal Protocol are used in our manufacturing processes, including in the manufacture of this product.
- (2) This product complies with the RoHS Directive (Restriction of the use of certain Hazardous Substances in electrical and electronic equipment (DIRECTIVE 2002/95/EC)).
- (3) All materials used in this product are existing chemical substances recognized under "lows on examination of chemical substances and regulations of manufacturing and others."
- (4) None of the materials used in this product contain the designated incombustible bromic substances, PBBOs and PBBs.
- (5) Please contact us to obtain a notice as to whether this product has passed inspection under review criteria primarily based on Foreign Exchange and Foreign Trade Control Laws, and appended table in the Export Control Laws.

13. Production site

Country: Japan

Plant: Panasonic Electronic Devices Japan Co., Ltd.

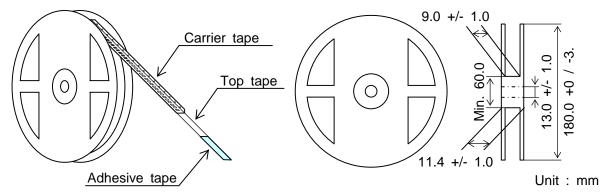
Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 9

14. Taped and Reel Package

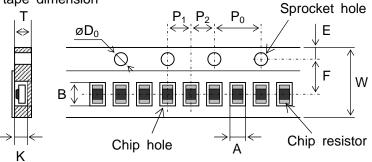
14-1 Physical Dimensions

Structure and reel dimensions shall be as shown in the figure below.

Inaccordance with EIAJ ET-7200.



14-2 Carrier tape dimension



	А	В	W	F	Е
Dimension (mm)	0.38+/-0.05	0.68+/-0.05	8.00+/-0.20	3.50+/-0.05	1.75+/-0.10

	P_1	P_2	P_0	$ \emptyset D_0 $	Т	K
Dimension (mm)	2.00+/-0.10	2.00+/-0.05	4.00+/-0.10	1.50+0.10/-0	0.42+/-0.05	0.29+/-0.05

14-3 Specifications

14-3-1 Taping

(1) Minimum Bending Radius

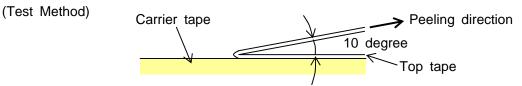
When Carrier tape shall be bent by Minimum Bending Radius (15mm), no defection of chip and no break of carrier tape. However minimum bending radius shall be tested for 1 time.

(2) Resistance to climate of top tape

When it shall be exposed at 60 deg.C, 90 to 95 %RH for 120 hours, no exfoliation of top tape.

Subject		Spec. No.
Chip Resistor	PRODUCT SPECIFICATION FOR IMFORMATION	151-SRJ-E8062A
Part No.		
	ERJ1GN	10 - 10

(3) When the test shall be operated with the below conditions, peel strength should be 0.049 N to 0.49 N, should not have flash and tear after peeling.

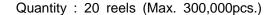


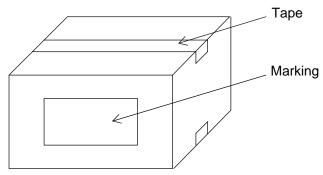
14-3-2 Quantity in Taping: 15000 pcs./reel

14-3-3 Tape packaging

- (1) Resistance side shall be facing upward.
- (2) Chip resistor shall not be sticking to top tape.
- (3) Chip resistor shall be easy to take out from carrier tape and chip hole or sprocket hole shall not have flash and break.

14-4 Outer Packaging





- * When taping shall not reach Max. or quantity, the remaining empty space shall be buried with buffer material.
- * When the quantity shall be few, alternative packaging methods may be used. No problem must occur during the exportation of the product.

14-5 Marking

At last, production country is displayed in English.

- (1) Side of reel (Marking shall be on one side)
 - 1)Part name, 2)Part number, 3)Quantity, 4)Lot number, 5)Maker name
 - 6) Production country

(2)Packaging box

1)Customer name, 2)Part name, 3)Part number, 4)Customer part number, 5)Quantity 6)Maker name, 7)Production country